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RT3215-32.768-6-TR

SPECIFICATIONS

| PARAMETER | VALUE | |
|------------------------------|---------------------------------|--|
| NOMINAL FREQUENCY | 32.768 kHz | |
| MODE OF OSCILLATION | Fundamental | |
| FREQUENCY TOLERANCE AT 25°C | ±20 ppm max | |
| TURNOVER TEMPERATURE | +25 ± 5°C | |
| TEMPERATURE COEFFICIENT | -0.04 ppm / °C ² max | |
| OPERATING TEMPERATURE RANGE | -40°C to +85°C | |
| STORAGE TEMPERATURE RANGE | -55°C to +125°C | |
| AGING | ±3 ppm first year max | |
| LOAD CAPACITANCE | 6 pF | |
| EQUIVALENT SERIES RESISTANCE | 70 kΩ max | |
| SHUNT CAPACITANCE | 1.1 pF typ | |
| DRIVE LEVEL | 0.5 µW max | |
| INSULATION RESISTANCE | 500 MΩ min @ DC 100V | |



Photo not actual part

MECHANICAL SPECIFICATION





CARRIER TAPE DIMENSIONS

NOTE: REFER TO EIA-481 FOR DIMENSIONS

PACKAGING

180 mm REEL DIAMETER 12 mm TAPE WIDTH, 4 mm PITCH QUANTITY: 3000 PIECES PER REEL

IN ACCORDANCE WITH EIA-481



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• REFLOW PROFILE



| Reflow profile | | | |
|--|-------------------|--------------|--|
| Temperature Min Preheat | T _{SMIN} | 150°C | |
| Temperature Max Preheat | T _{SMAX} | 200°C | |
| Time (T _{SMIN} to T _{SMAX}) | t _S | 60-180 sec. | |
| Temperature | ΤL | 217°C | |
| Peak Temperature | T _P | 260°C | |
| Ramp-up rate | R _{UP} | 3°C/sec max. | |
| Ramp-down rate | R _{DOWN} | 6°C/sec max. | |
| Time within 5°C of Peak Temperature | t _P | 10 sec. | |
| Time t[25°C] to Peak Temperature | t[25°C] to Peak | 480 sec. | |
| Time | tL | 60-150 sec. | |

ENVIRONMENTAL

| PARAMETER | VALUE |
|----------------------------|-----------|
| MOISTURE SENSITIVITY LEVEL | 1 |
| RoHS | Compliant |
| REACH SVHC | Compliant |
| HALOGEN-FREE | Compliant |
| ESD CLASSIFICATION LEVEL | N/A |
| TERMINATION FINISH | Au |





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MARKING

| Xywwx | X – Internal Production ID code (J, R, T, Y, M, R, N, AA) y – Year code ww – Week code x - 1 or 2 digits as Lot code |
|-----------------------------------|--|
| ymxxx | y – Year code m – Month code, Jan ~ Sep: 1 ~ 9, Oct: X Nov: Y Dec: Z xxx – Lot code |
| XLzymd | X – Internal Production ID code (J, R, T, Y, M, R, N, AA) L – Load capacitance code (A: 12.5pF B: 9pF C: 7pF Z: others) z – Lot code y – Year code m – Month code, Jan ~ Sep: 1 ~ 9, Oct: X Nov: Y Dec: Z d – Day code |
| XzymF ^{xx} _{xx} | X – Internal Production ID code (J, R, T, Y, M, R, N, AA) z – Frequency code y – Year code m – Month code, Jan ~ Sep: 1 ~ 9, Oct: X Nov: Y Dec: Z ^{xx} _{xx} – Lot code |
| Xywwx 32.768 | X – Internal Production ID code (J, R, T, Y, M, R, N, AA) y – Year code ww – Week code x – 1 or 2 digits as Lot code |
| 32.768 | |
| ЗХух | 3 – Item code X – Internal Production ID code (J, R, T, Y, M, R, N, AA) y – Year code x – 1 or 2 digits as Lot code |



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APPROVAL

| Drawn By: | FP, 20 January 2014 |
|--------------|--|
| Approved By: | FP, 20 January 2014 |
| Revision: | A, Initial Release |
| | B, KJ, 7/26/16 Corrected Tape Width to 12mm; Peak Temperature 260°C |
| | C, Updated to current spec levels KJ 5/15/17, Updated to current spec levels by XL 5/10/2019 |
| | D, Added markings by XLiu, December 10, 2020 |
| | E, AR January 07, 2021 |
| | Updated the Carrier Tape Dimensions |
| | F, Add reliability conditions by XLiu, April 28, 2022 |

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RELIABILITY SPECIFICATIONS

| Test Item | Test Methods/Conditions | Test Criteria |
|---------------------------------|---|---|
| High Temp Storage | Temperature: $125^{\circ}C \pm 5^{\circ}C$ for 1000 ± 12 hours. (If Customer's temperature request is higher than the standard, Temperature test must be done for customer requirements.) Then $25 \pm 2^{\circ}C$ over 2h before testing | ⊿Freq.≤±20ppm, ⊿RR ≤±5kΩ or 20% |
| Low Temp Storage | $-40^{\circ}C \pm 2^{\circ}C$ for 500 \pm 12 hours. (If Customer's temperature request is lower than the standard, Temperature test must be done for customer requirements.) Then 25 \pm 2°C over 2h before testing | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |
| High Temp. & Humidity | Temperature: 85°C ±2°C Relative Humidity: 85% Time: 500 \pm 12 hours. Then 25 ±2°C over 2hours before testing | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% Insulation resistance 500MΩ min, at DC100V |
| Thermal Shock | The crystal unit shall be subjected to 100 successive change of Temperature cycles, then 25±2°C over 2hours before testing, Each Cycle as bellow, -40°C +0/-6°C for 30 ±3 minutes 25°C ±2°C for 2~3 minutes 125°C +4/-0°C for 30 ±3 minutes 25°C ±2°C for 2~3 minutes | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |
| Resistance to Soldering Heat | Reflows two times, then $25 \pm 2^{\circ}$ C over 2h before testing | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |
| Drop Test | Free drop from 100cm for 3 times on hardWood. | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |



SURFACE MOUNT MICROPROCESSOR CRYSTAL

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| | | RT3215-32.768-6 |
|-----------------------------------|--|--|
| | Frequency: 10 to 55Hz, | |
| | full wave Amplitude: 1.5 \pm 15% mm (Peak to Peak) | ⊿Freq.≤±10ppm, |
| Vibration | Sweep/Cycle: 2~3 minutes, 3 Directions: X,Y,Z Duration: 2 hours in each direction | ⊿RR ≤±5kΩ or 20% |
| Solderability | The lead is immersed in a 260 $\pm5^\circ\!\!\mathbb{C}$ solder bath for 2 \pm 0.6 seconds | The new uniform solder coating coverage 95 % minimum. |
| Fine Leak | Helium bombing 5~5.5 kgf/cm2 for 2 hours, then tested with a heliun mass spectrometry leak detector. | Air Leak rate<1 x 1E-9Pa.m3/s) |
| Machanical Shock | 100g 6ms | ⊿Freq.≤±10ppm, |
| Mechanical Shuck | | ⊿RR ≤±5kΩ or 20% |
| | A R0.5 pressurized bar shall be used to apply a 10N load in the center of element and retain it for 10seconds. | |
| | ла во. 5 可移动夹具 | ⊿Freq.≤±5ppm, |
| Sticking Tendency | | ⊿RR ≤±5kΩ or 15% |
| | Shall be pressurized at a speed of approx. 0.5mm/sec. in the direction indicated by the arrow until bending width 3mm and held for 5 seconds. | |
| Board Flex Test | PRESSURE ROD R20 R5 AMPLE A R5 45±9 行测物 ^{45±2} | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |
| Element Assembly Strength Test | A R0.5 pressurized bar shall be used to apply a 10N load in the center of element and retain it for 10seconds. R0.5可移动夹具 PRESSUER ROD R0.5 SAMPLE 待测物 | ⊿Freq.≤±10ppm, ⊿RR ≤±5kΩ or 20% |